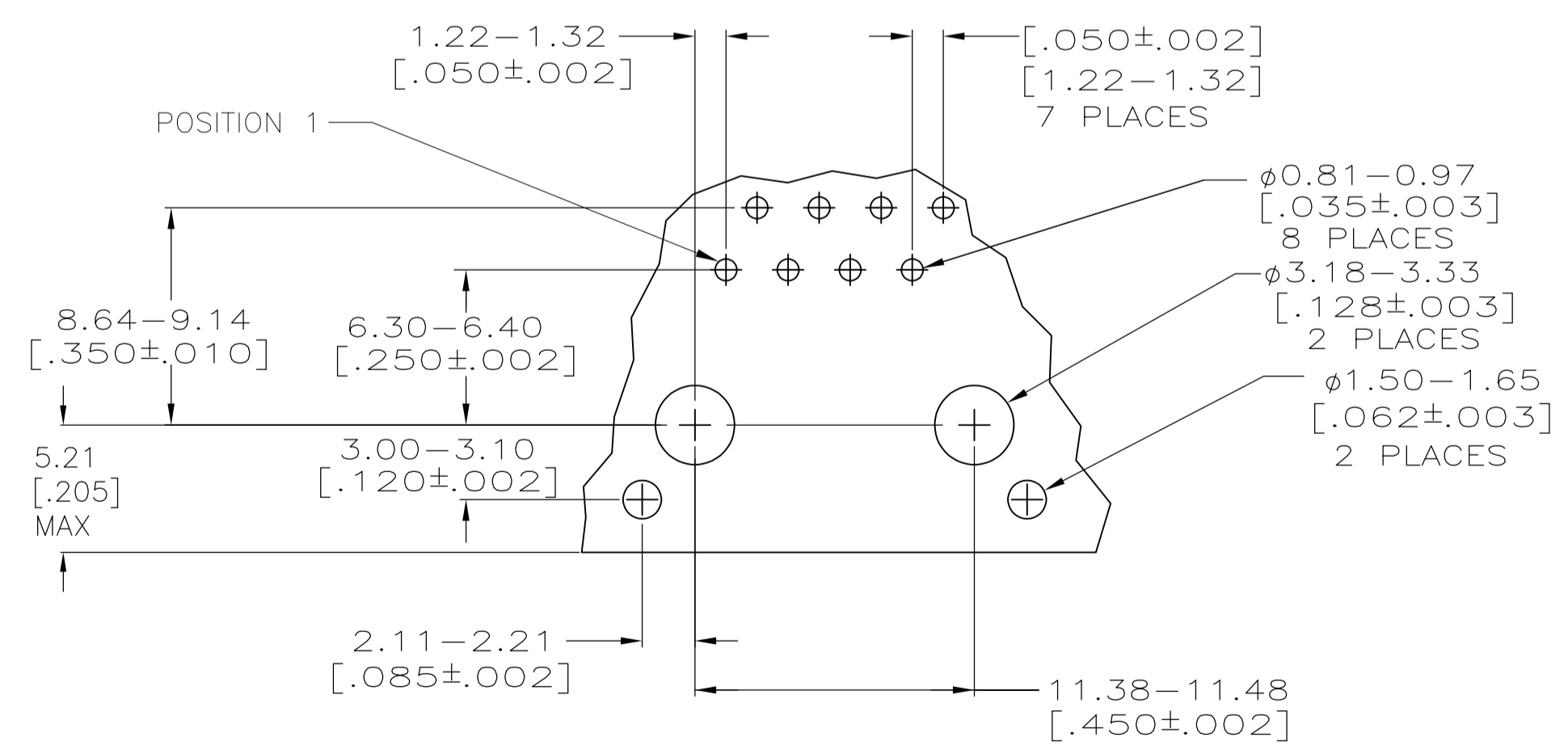
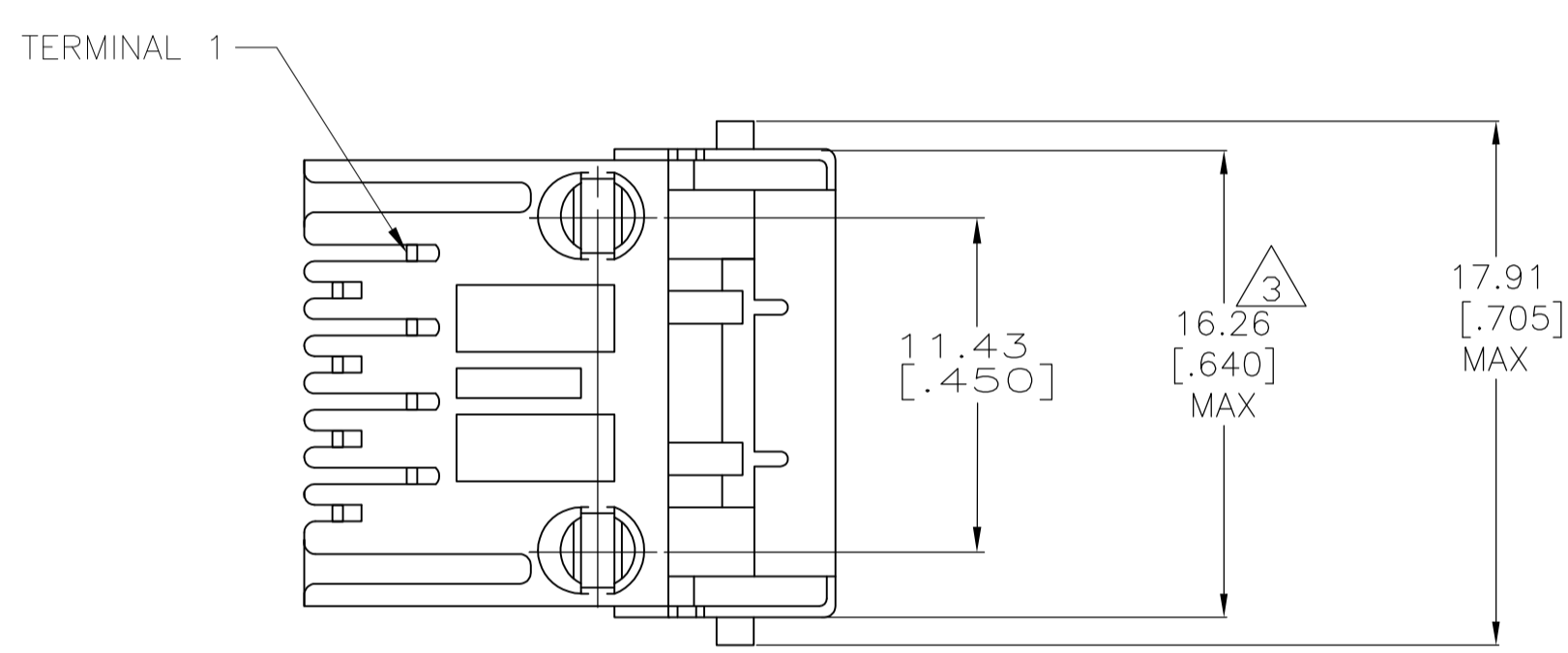
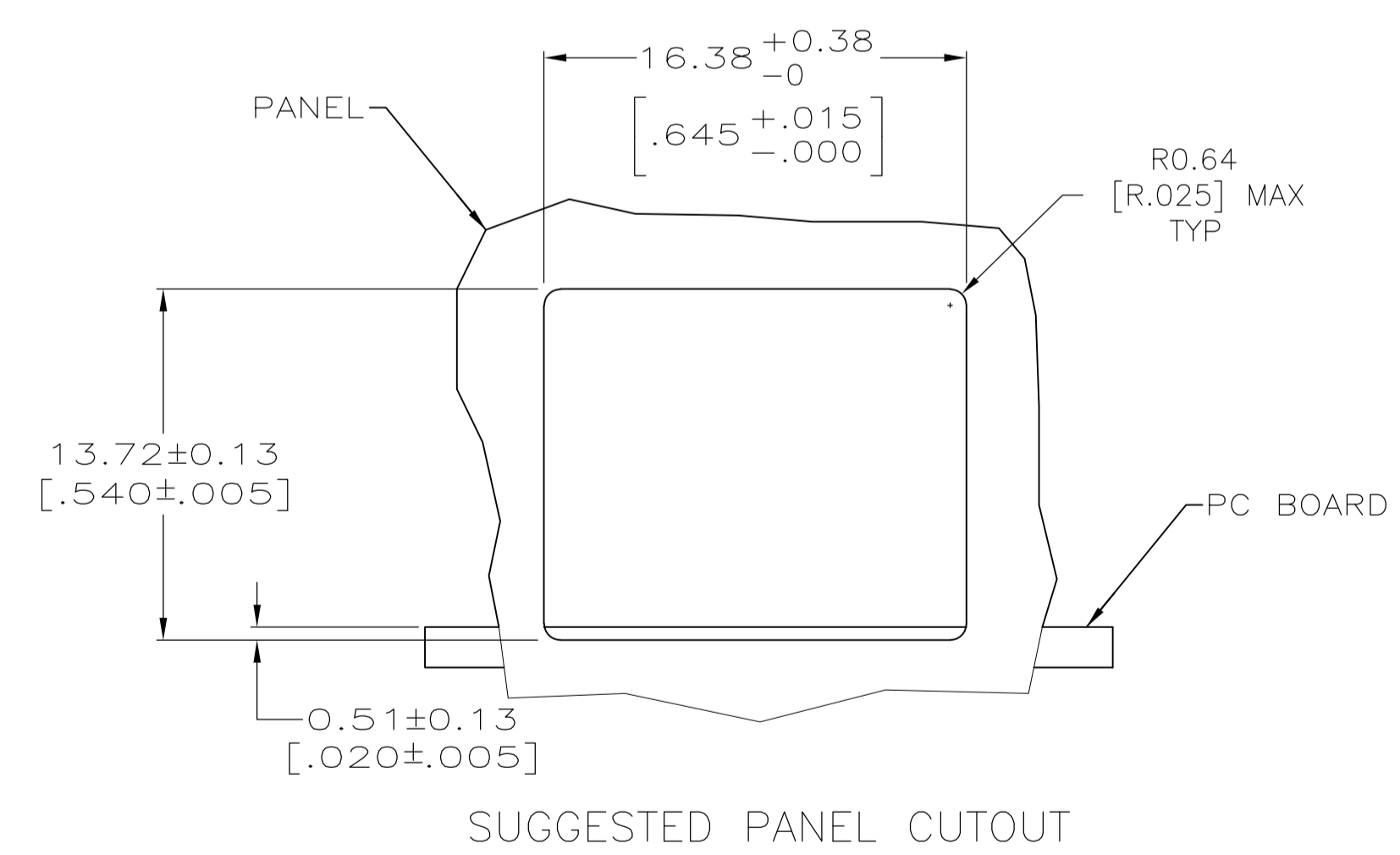


- MATERIAL:
 HOUSING-PBT POLYESTER BLACK.
 TERMINAL- 0.36 [.014] THICK PHOS-BRONZE PLATE WITH 1.27μm [.000050] MIN THICK HARD GOLD IN LOCALIZED GOLD PLATE AREA AND 3.81μm [.000150] MIN THICK MATTE TIN IN SOLDER AREA OVER 1.27μm [.000050] MIN THICK NICKEL UNDERPLATE.
 SHIELD- 0.25 [.010] THICK COPPER ALLOY, PLATE WITH 3.0μm [.000120] MIN THICK REFLOWED TIN

- △ CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68, SUBPART F.
- △ DIMENSION MEASURED ALONG FRONT EDGE OF MATING SURFACE



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
 COMPONENT SIDE



SUGGESTED PANEL CUTOUT

5558382-1
 PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN A. FERNANDEZ 08JUN2005	Tyco Electronics Corporation Harrisburg, Pa 17105-3608	
DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED:	CHK J. WESTMAN 08JUN2005	NAME S. FLICKINGER 08JUN2005	PRODUCT SPEC 108-1163
	0 PLC ± -	APVD S. FLICKINGER 08JUN2005	APPLICATION SPEC 114-2048	RESTRICTED TO
	1 PLC ± -	SIZE A1	SCALE 4:1	
	2 PLC ± ± 0.13[.005]	WEIGHT -	SHEET 1 OF 1	
	3 PLC ± ± -	CUSTOMER DRAWING	REV C	
	4 PLC ± ± -			
	ANGLES ± ± -			
MATERIAL SEE NOTE 1	FINISH SEE NOTE 1			